

Persistent Memory Is the Answer to Today's Data Center Challenges

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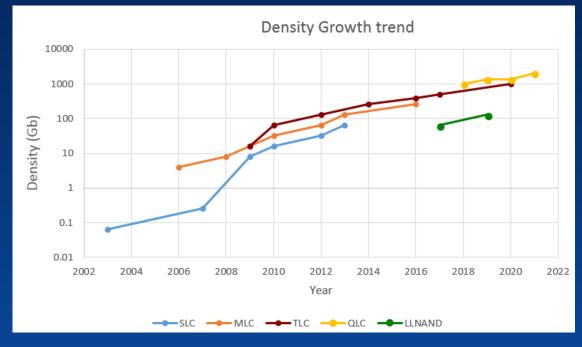
Agenda

Flash Memory Summit

- 3D NAND Scaling and cost reduction has fueled a disruption in the data center
- Persistent Memory and its arduous journey into the Data Center
- Use Case #1 Persistence
- Use Case #2 External Storage Consistency Enhancer
- Use Case #3 Hot Tier
- Use Case #4 Super Fast Tier 0
- What will Change
- Where are things headed



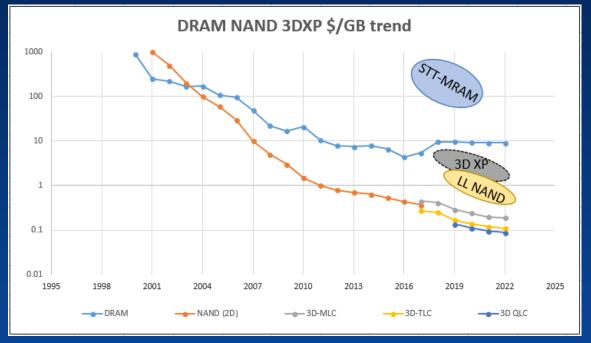
Memory density trend



- Flash density growth will continue via 3D NAND layer count scaling 2018-2022+
- Significant fab investments ongoing for new flash Fabs in 2018-20
- 3D NAND layer count scaling provides clear path for flash density growth TLC, QLC, LL-NAND
- 3D NAND scaling on a 18-24 month cadence thru 2020 64L > 96L >120L >190L

\$/GB trend for DRAM, NAND and SCM





- Flash Market Demand growth driven by high density 3D NAND, Enterprise SSD, Mobile applications growth
- 3D NAND bit cost reduction achieved by 3D Cell layer increases
- Strong penetration of 3D TLC in Cloud Datacenter & Enterprise Storage in 2018-19.



Persistent memory and talk of Persistent memory is Everywhere!

- MRAM in embedded, other places. Even in the new IBM NVMe Flash Core module
- 3DXP Optane Fast Tier
- 3DXP on DRAM bus
- LL NAND
- Spin Torque, RRAM, Phase Change
- Exotics



Persistence

DRAM is one of the most important inventions of all time

-- BUT --

- Super caps and batteries are a pain!
 - (No offense to any super cap providers or battery providers in the audience)
- MRAM is providing a small persistent embedded memory for many applications
- Used in New FS9100 FCM
- 3DXP could eventually get rid of batteries in fast write caches
- However, not the highest priority.



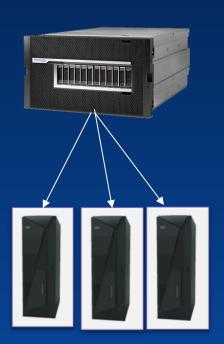
Storage Consistency Enhancer

- Flash has significantly reduced average response time
- Snapshots, Data Reduction metadata (LSA), and other structures being out of cache can cause latency spikes
- Storing metadata, bitmaps and other structures in persistent fast storage can make response time conistency



Hot Tier

- Flash entered the data center via this mechanism
- Still prevalent in thousands of data centers around the world
- Topologies
 - In the storage array
 - As a tier 0 in a virtualized storage system
 - In the server as an HBA or NVMe card





Super Fast Tier 0

- Today's tier 0 with flash are ~100uS
- NVMe over Fabrics can reduce that to * ~70uS



3DXP as DRAM – Less





How will Fast Tier 0 be used with Persistent Memory

- FS 900 Tier 0 has been very successful
- Relational database accelerators
- Metadata for Scaleout filesystems
- Fast Write Buffers for HPC
- Smart Tiering in Analytics
- Still can not execute out of it unless on DRAM bus



Applications that can take advantage

- Throughput and tiers in Machine learning and Deep Learning and analytics for data at rest
- Metadata
- Real Time Analytics



What will Change

- 3DXP on the DRAM bus
- Metadata
- Real Time Analytics